11/11/19 V1.0

Surface Mount RGB LED **multicomp** PRO 3.5mm × 2.8mm

RoHS **Compliant**



Features

- Forward Current: R≦50mA; G and B≦30mA •
- Typical view angle 50% lv: 120°
- Lens Colour: white diffused
- ESD level 1kV(HBM)

Maximum Rating ($T_A = 25^{\circ}C$)

Characteristics	Symbol	Typical	Unit
DC Forward Current	lf	G&B≦30 / R≦50	mA
Pulse Forward Current*3	IPF	80	mA
Reverse Voltage	VR	5	V
Power Dissipation	PD	G&B:80 / R:100	mW
Junction Temperature	TJ	110	
Operating Temperature Range	Тор	-40 to +80	°C
Storage Temperature Range	Тѕтс	-40 to +100	
Soldering Temperature ^{*4}	Tsd	260	

Notes

1: There is no maximum or typical voltage parameter

2: For other ambient, limited setting of current will be depended on de-rating curves.

3: Duty 1/10, pulse width 0.1ms

4: The maximum of soldering time is 5 seconds in TSD

Typical Product Characteristics (T_A = 25°C)

Characteristics	Syn	nbol	Min.	Typical	Max.	Unit	Test condition
Forward Voltage	VF	R	1.8	2.1	2.6	V	I⊧ = 20mA
		G	2.8	3.2	3.6		
		В	2.8	3.2	3.6		
Reverse Current	lr		-	-	10	μA	Vr = 5V
Luminous Intensity	lv	R	160	235	-	mcd	I⊧ = 20mA
		G	800	1200	-		
		В	250	350	-		
Dominant Wavelength	λd	R	615	622	630	nm	IF = 20mA
		G	519	525	534		
		В	461	468	476		
View Angle	20	1/2	-	120	-	deg	IF = 20mA

Notes:

1. Measurement Errors: -, Forward Voltage: ±0.1V, Luminous Intensity: ±10%Iv, Dominant Wavelength: ±1.0nm

2. Electrical-Optical Characteristics (T_A = 25°C)

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Applications

Indoor decorating

Consumer electronics

Outdoor lighting for amusement

Electronic-Optical Characteristics Curves







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Forward Current (mA)

20

3). Relative Luminous Flux .Current









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Diagram







Dimensions : Millimetres

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multicomp PRO

Recommend Pad layout



Dimensions : Millimetres Tolerance is ±0.1mm

Reflow Profile

1. IR reflow soldering Profile for Lead Free solder



Notes

- 1. We recommend the reflow temperature 240°C (±5°C).the maximum soldering temperature should be limited to 260°C.
- 2. Don't cause stress to the silicone resin while it is exposed to high temperature.
- 3. Number of reflow process shall be less than 3 times.

Part Number Table

Description	Part Number	
Surface Mount RGB LED - 3.5mm × 2.8mm	MP001251	

2. IR reflow soldering Profile for Lead solder

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